506900389 10/01/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MIN-HUNG HU	09/15/2020

RECEIVING PARTY DATA

Name:	RICHTEK TECHNOLOGY CORPORATION
Street Address:	14F., NO. 8, TAIYUAN 1ST ST.
City:	ZHUBEI CITY, HSINCHU
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17491578

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: RANDY TUNG

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ATTORNEY DOCKET NUMBER:	92000-673(RH-1513)
NAME OF SUBMITTER:	RANDY W TUNG
SIGNATURE:	/Randy W Tung/
DATE SIGNED:	10/01/2021

Total Attachments: 1

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PATENT 506900389 REEL: 057664 FRAME: 0836

92000-673

RH-1513 V109-005

ASSIGNMENT

WHEREAS, I/we, Min-Hung Hu, have invented certain improvements in:

"MULTI-STAGE AMPLIFIER CIRCUIT"

for which I am/we are about to make application for Letters Patent of the United States; and WHEREAS, Richtek Technology Corporation, a company having a business address in R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, Min-Hung Hu, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the following execution date, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filled on said invention in countries foreign to the United States and any Letters Patent granted thereon.

I/we further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I/we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

a M Ema H ai M	2000/09/15
(Signature by first inventor/assignor)	(Date)

TUNG & ASSOCIATES 7010 Middlebelt Road Garden City, MI 48135

> PATENT REEL: 057664 FRAME: 0837

RECORDED: 10/01/2021